

### 1.6x0.8x0.5mm BI-COLOR SURFACE MOUNT **LED**



**ATTENTION** 

OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE **DEVICES** 

Part Number: APHB1608ZGSURKC

Green Hyper Red

### **Features**

- 1.6mmX0.8mm SMT LED, 0.5mm thickness.
- · Compatible with reflow soldering.
- Available in various color combination.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

### Description

The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.

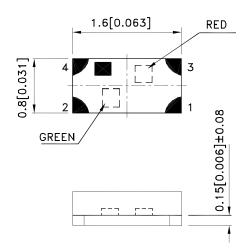
The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

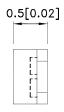
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

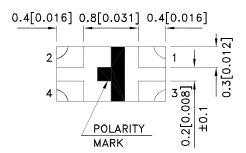
All devices, equipment and machinery must be electrically grounded.

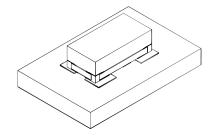
### **Package Dimensions**











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

**REV NO: V.1A DATE: JUN/28/2013** SPEC NO: DSAN0769 **APPROVED: WYNEC CHECKED: Allen Liu** DRAWN: Y.Liu



PAGE: 1 OF 6 ERP: 1203011134

### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA			Viewing Angle [1]
			Min.	Тур.	Max.	201/2
APHB1608ZGSURKC	Green (InGaN)	- Water Clear	200	-	500	- 130°
			*200	-	*500	
	Hyper Red (AlGaInP)		120	250	-	
			*40	*90	1	

- Notes:
  1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
  2. Luminous intensity/ luminous Flux: +/-15%.
  \* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green Hyper Red	515 645		nm	IF=20mA
λD [1]	Dominant Wavelength	Green Hyper Red	525 630		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green Hyper Red	30 28		nm	IF=20mA
С	Capacitance	Green Hyper Red	45 35		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green Hyper Red	3.3 1.95	4.1 2.5	V	IF=20mA
lr	Reverse Current	Green Hyper Red		50 10	uA	V <sub>R</sub> = 5V

### Notes:

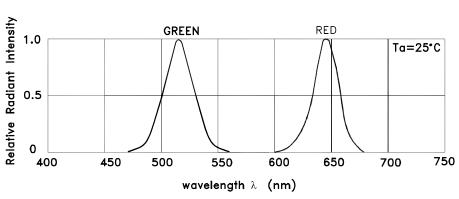
- 1.Wavelength: +/-1nm.
  2. Forward Voltage: +/-0.1V.
  3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

## Absolute Maximum Ratings at TA=25°C

Parameter	Green	Hyper Red	Units			
Power dissipation	102.5	75	mW			
DC Forward Current	25	30	mA			
Peak Forward Current [1]	150	185	mA			
Reverse Voltage	· ·	V				
Operating Temperature	-40°C To +85°C					
Storage Temperature	-40°C To +85°C					

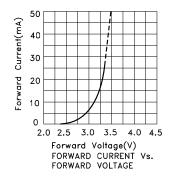
DATE: JUN/28/2013 SPEC NO: DSAN0769 **REV NO: V.1A** PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.Liu ERP: 1203011134

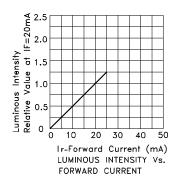
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

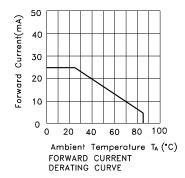


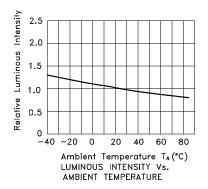
RELATIVE INTENSITY Vs. WAVELENGTH

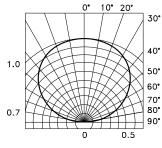
## APHB1608ZGSURKC Green









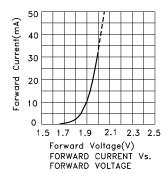


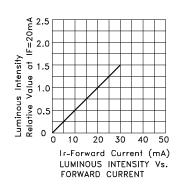
SPATIAL DISTRIBUTION

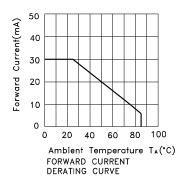
 SPEC NO: DSAN0769
 REV NO: V.1A
 DATE: JUN/28/2013
 PAGE: 3 OF 6

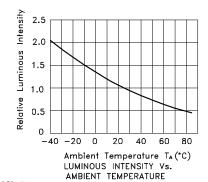
 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: Y.Liu
 ERP: 1203011134

### **Hyper Red**



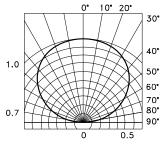






PAGE: 4 OF 6

ERP: 1203011134



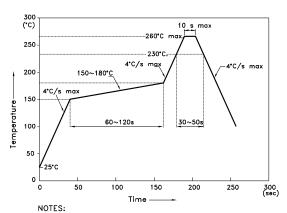
SPATIAL DISTRIBUTION

SPEC NO: DSAN0769 REV NO: V.1A DATE: JUN/28/2013
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.Liu

### APHB1608ZGSURKC

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



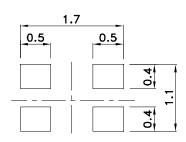
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

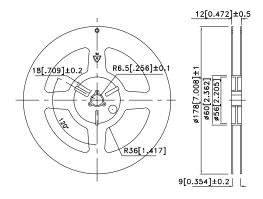
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

  3.Number of reflow process shall be 2 times or less.

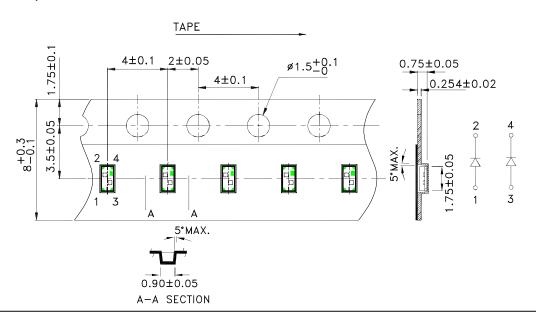
### **Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



### **Reel Dimension**



### **Tape Dimensions** (Units: mm)



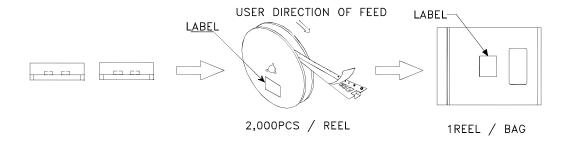
SPEC NO: DSAN0769 APPROVED: WYNEC

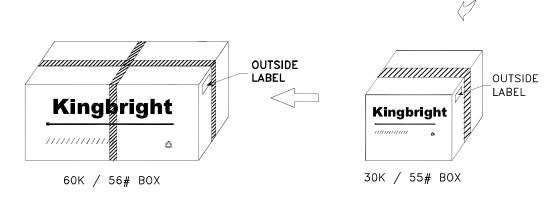
**REV NO: V.1A CHECKED: Allen Liu**  **DATE: JUN/28/2013** DRAWN: Y.Liu

PAGE: 5 OF 6 ERP: 1203011134

### **PACKING & LABEL SPECIFICATIONS**

### APHB1608ZGSURKC







All design applications should refer to Kingbright application notes available at <a href="http://www.KingbrightUSA.com/ApplicationNotes">http://www.KingbrightUSA.com/ApplicationNotes</a>

SPEC NO: DSAN0769 APPROVED: WYNEC REV NO: V.1A CHECKED: Allen Liu DATE: JUN/28/2013 DRAWN: Y.Liu PAGE: 6 OF 6 ERP: 1203011134

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Standard LEDs - SMD category:

Click to view products by Kingbright manufacturer:

Other Similar products are found below:

LTST-C190KYKT LTST-C19GD2WT LTST-N683GBEW LTW-170ZDC LTW-M140SZS40 LTW-M140ZVS 598-8110-100F 598-8170
100F 598-8610-202F 67-22VRVGC/TR8 AAAF5060QBFSEEZGS HLMA-QG00-S0021 HLMP-6305-L0011 ALMD-LB36-SV002

APT1608QGW 15-21UYC/S530-A3/TR8 EAST2012YA0 EASV1803BA0 LG M67K-H1J2-24-0-2-R18-Z LS A676-P2S1-1

SML310BATT86 SML-512VWT86A SML-LX0606SISUGC/A SML-LXL1307SRC-TR SML-LXR851SIUPGUBC LT1ED53A FAT801-S

AM27ZGC03 APB3025SGNC APFA3010SURKCGKQBDC APHK1608VGCA APT2012QGW CLX6D-FKB-CN1R1H1BB7D3D3 LTST
C250KGKT LTW-010DCG LTW-020ZDCG LTW-21TS5 LTW-220DS5 JANTXM19500/521-02 UYGT801-S 42-21UYC/S530-A3/TR8

LO T67F-V1AB-24-1 YGFR411-H 598-8330-117F SML-LX0402IC-TR CMDA20AYAA7D1S CMDA16AYDR7A1X 598-8040-100F 598-8070-100F 598-8140-100F